



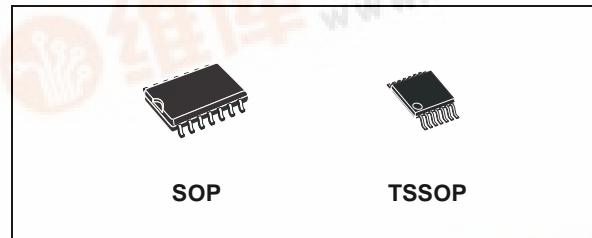
# 74LCX04

## LOW VOLTAGE CMOS HEX INVERTER WITH 5V TOLERANT INPUTS

- 5V TOLERANT INPUTS
- HIGH SPEED :  
 $t_{PD} = 5.2\text{ns}$  (MAX.) at  $V_{CC} = 3\text{V}$
- POWER DOWN PROTECTION ON INPUTS AND OUTPUTS
- SYMMETRICAL OUTPUT IMPEDANCE:  
 $|I_{OHI}| = I_{OL} = 24\text{mA}$  (MIN) at  $V_{CC} = 3\text{V}$
- PCI BUS LEVELS GUARANTEED AT 24 mA
- BALANCED PROPAGATION DELAYS:  
 $t_{PLH} \approx t_{PHL}$
- OPERATING VOLTAGE RANGE:  
 $V_{CC}(\text{OPR}) = 2.0\text{V}$  to  $3.6\text{V}$  (1.5V Data Retention)
- PIN AND FUNCTION COMPATIBLE WITH 74 SERIES 04
- LATCH-UP PERFORMANCE EXCEEDS 500mA (JESD 17)
- ESD PERFORMANCE:  
HBM > 2000V (MIL STD 883 method 3015); MM > 200V

### DESCRIPTION

The 74LCX04 is a low voltage CMOS HEX INVERTER fabricated with sub-micron silicon gate and double-layer metal wiring C<sup>2</sup>MOS



### ORDER CODES

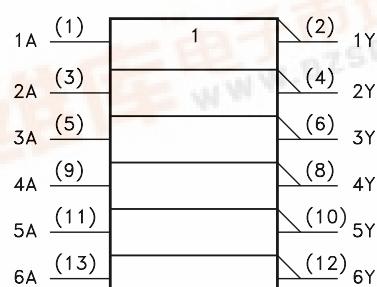
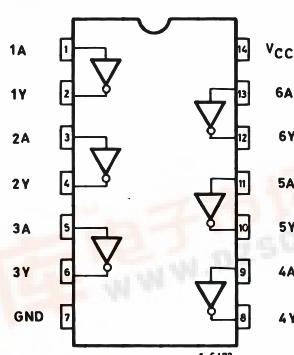
PACKAGE	TUBE	T & R
SOP	74LCX04M	74LCX04MTR
TSSOP		74LCX04TTR

technology. It is ideal for low power and high speed 3.3V applications. It can be interfaced to 5V signal environment for inputs.

It has same speed performance at 3.3V than 5V AC/ACT family, combined with a lower power consumption.

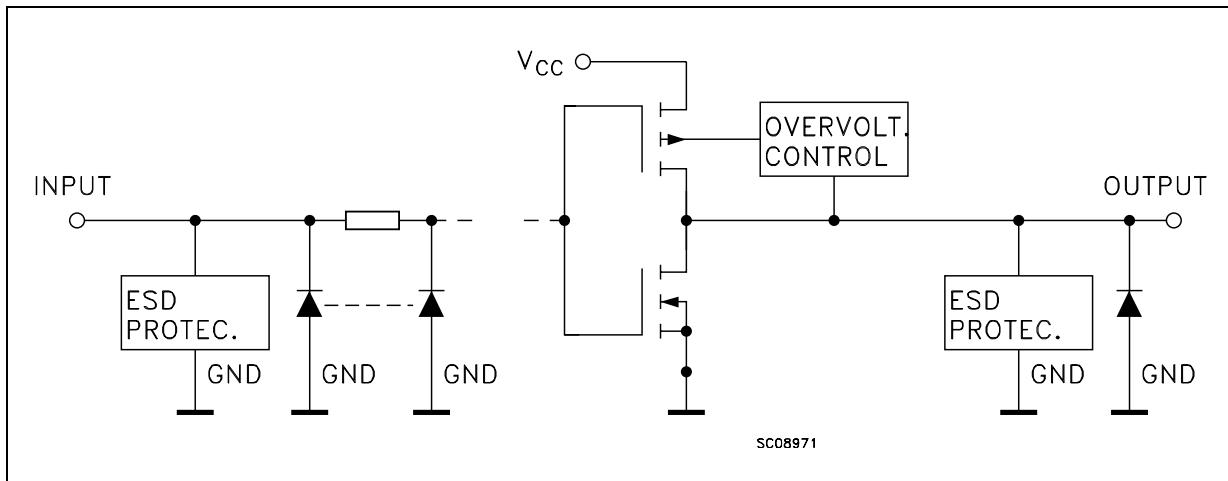
All inputs and outputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

### PIN CONNECTION AND IEC LOGIC SYMBOLS



# 74LCX04

## INPUT AND OUTPUT EQUIVALENT CIRCUIT



## PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
1,3,5,9,11,13	1A to 6A	Data Inputs
2, 4, 6, 8, 10, 12	1Y to 6Y	Data Outputs
7	GND	Ground (0V)
14	V <sub>CC</sub>	Positive Supply Voltage

## TRUTH TABLE

A	Y
L	H
H	L

## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	-0.5 to +7.0	V
V <sub>I</sub>	DC Input Voltage	-0.5 to +7.0	V
V <sub>O</sub>	DC Output Voltage (V <sub>CC</sub> = 0V)	-0.5 to +7.0	V
V <sub>O</sub>	DC Output Voltage (High or Low State) (note 1)	-0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	DC Input Diode Current	- 50	mA
I <sub>OK</sub>	DC Output Diode Current (note 2)	- 50	mA
I <sub>O</sub>	DC Output Current	± 50	mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	± 100	mA
I <sub>GND</sub>	DC Ground Current per Supply Pin	± 100	mA
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
T <sub>L</sub>	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

1) I<sub>O</sub> absolute maximum rating must be observed

2) V<sub>O</sub> < GND

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage (note 1)	2.0 to 3.6	V
$V_I$	Input Voltage	0 to 5.5	V
$V_O$	Output Voltage ( $V_{CC} = 0V$ )	0 to 5.5	V
$V_O$	Output Voltage (High or Low State)	0 to $V_{CC}$	V
$I_{OH}, I_{OL}$	High or Low Level Output Current ( $V_{CC} = 3.0$ to 3.6V)	$\pm 24$	mA
$I_{OH}, I_{OL}$	High or Low Level Output Current ( $V_{CC} = 2.7V$ )	$\pm 12$	mA
$T_{op}$	Operating Temperature	-55 to 125	°C
$dt/dv$	Input Rise and Fall Time (note 2)	0 to 10	ns/V

1) Truth Table guaranteed: 1.5V to 3.6V

2)  $V_{IN}$  from 0.8V to 2V at  $V_{CC} = 3.0V$ 

## DC SPECIFICATIONS

Symbol	Parameter	Test Condition		Value				Unit	
		$V_{CC}$ (V)		-40 to 85 °C		-55 to 125 °C			
				Min.	Max.	Min.	Max.		
$V_{IH}$	High Level Input Voltage	2.7 to 3.6		2.0		2.0		V	
$V_{IL}$	Low Level Input Voltage				0.8		0.8		
$V_{OH}$	High Level Output Voltage	2.7 to 3.6	$I_O=-100 \mu A$	$V_{CC}-0.2$		$V_{CC}-0.2$		V	
		2.7	$I_O=-12 mA$	2.2		2.2			
		3.0	$I_O=-18 mA$	2.4		2.4			
			$I_O=-24 mA$	2.2		2.2			
$V_{OL}$	Low Level Output Voltage	2.7 to 3.6	$I_O=100 \mu A$		0.2		0.2	V	
		2.7	$I_O=12 mA$		0.4		0.4		
		3.0	$I_O=16 mA$		0.4		0.4		
			$I_O=24 mA$		0.55		0.55		
$I_I$	Input Leakage Current	2.7 to 3.6	$V_I = 0$ to 5.5V		$\pm 5$		$\pm 5$	μA	
$I_{off}$	Power Off Leakage Current	0	$V_I$ or $V_O = 5.5V$		10		10	μA	
$I_{CC}$	Quiescent Supply Current	2.7 to 3.6	$V_I = V_{CC}$ or GND		10		10	μA	
			$V_I$ or $V_O = 3.6$ to 5.5V		$\pm 10$		$\pm 10$		
$\Delta I_{CC}$	$I_{CC}$ incr. per Input	2.7 to 3.6	$V_{IH} = V_{CC} - 0.6V$		500		500	μA	

## DYNAMIC SWITCHING CHARACTERISTICS

Symbol	Parameter	Test Condition		Value			Unit	
		$V_{CC}$ (V)		$T_A = 25$ °C				
				Min.	Typ.	Max.		
$V_{OLP}$	Dynamic Low Level Quiet Output (note 1)	3.3	$C_L = 50pF$ $V_{IL} = 0V, V_{IH} = 3.3V$		0.8		V	
					-0.8			

1) Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH to LOW or LOW to HIGH. The remaining output is measured in the LOW state.

## 74LCX04

### AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Condition				Value				Unit	
		$V_{CC}$ (V)	$C_L$ (pF)	$R_L$ ( $\Omega$ )	$t_s = t_r$ (ns)	-40 to 85 °C		-55 to 125 °C			
						Min.	Max.	Min.	Max.		
$t_{PLH}$ $t_{PHL}$	Propagation Delay Time	2.7	50	500	2.5		6.0		6.9	ns	
		3.0 to 3.6				1.0	5.2		6.0		
$t_{OSLH}$ $t_{OSHL}$	Output To Output Skew Time (note1, 2)	3.0 to 3.6	50	500	2.5		1.0		1.0	ns	

1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ( $t_{OSLH} = |t_{PLHm} - t_{PLHn}|$ ,  $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$ )

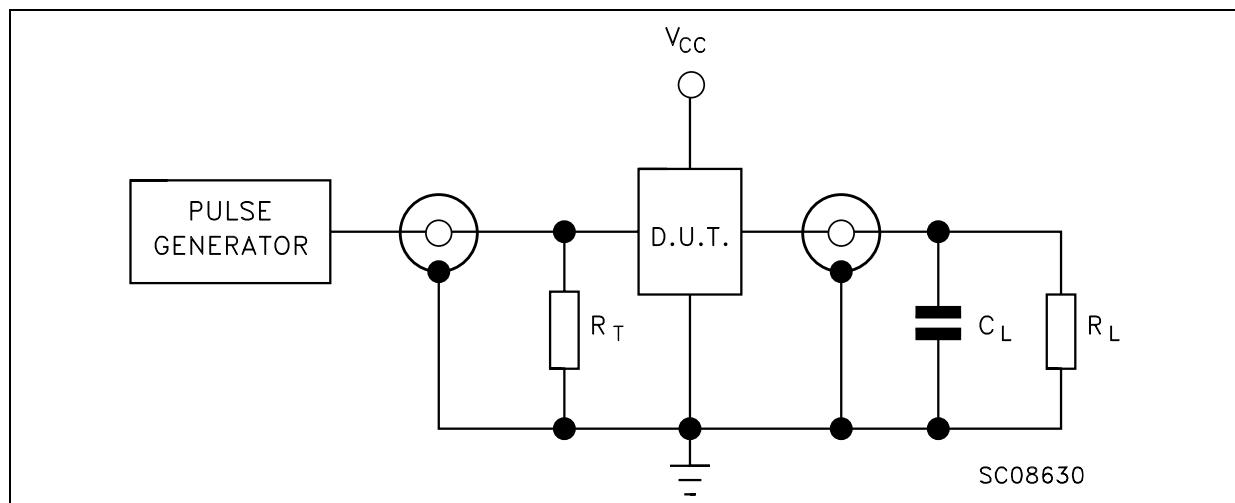
2) Parameter guaranteed by design

### CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Test Condition		Value			Unit	
		$V_{CC}$ (V)		$T_A = 25$ °C				
				Min.	Typ.	Max.		
$C_{IN}$	Input Capacitance	3.3	$V_{IN} = 0$ to $V_{CC}$		5		pF	
$C_{PD}$	Power Dissipation Capacitance (note 1)	3.3	$f_{IN} = 10\text{MHz}$ $V_{IN} = 0$ or $V_{CC}$		41		pF	

1)  $C_{PD}$  is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation.  $I_{CC(\text{opr})} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/6$  (per gate)

### TEST CIRCUIT

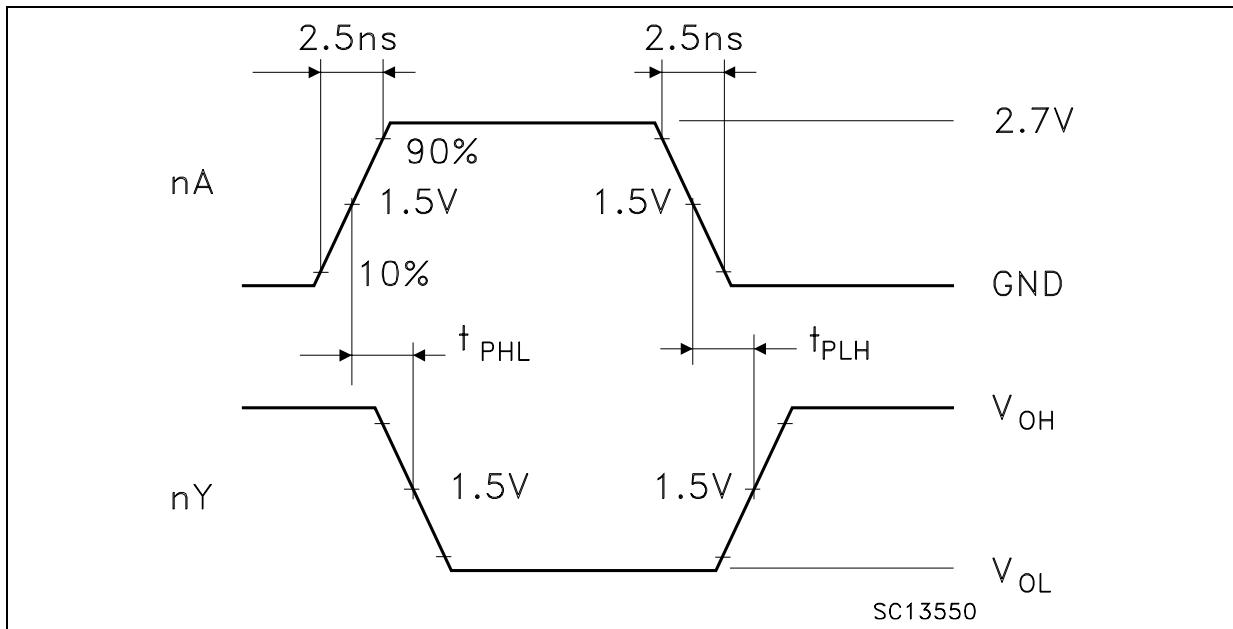


$C_L = 50$  pF or equivalent (includes jig and probe capacitance)

$R_L = 500\Omega$  or equivalent

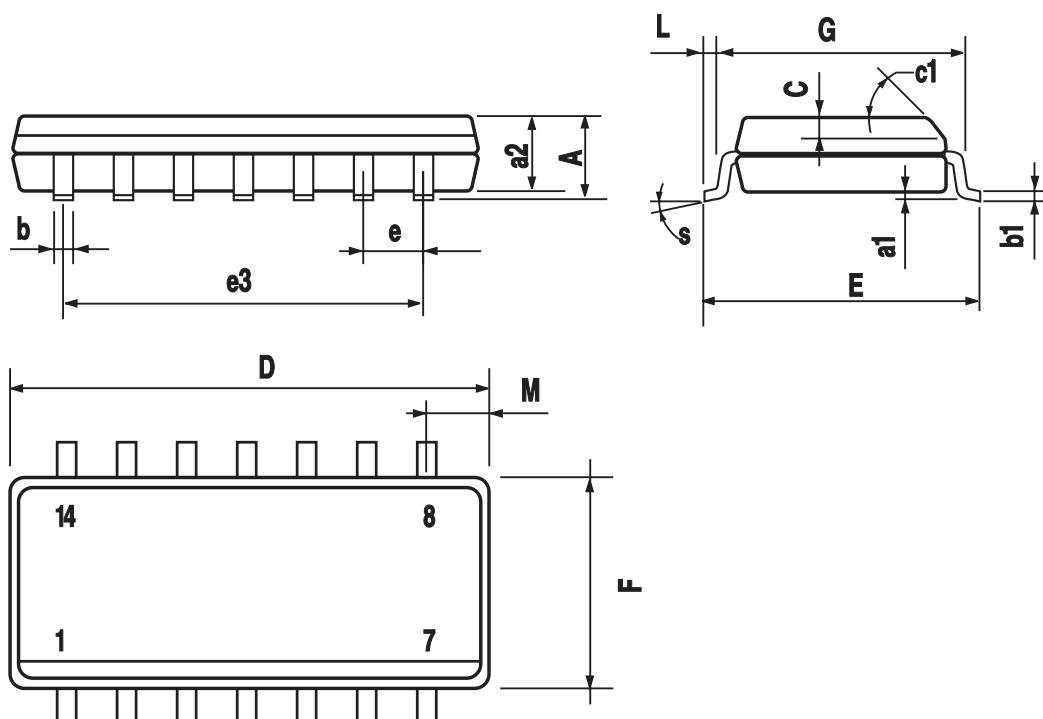
$R_T = Z_{OUT}$  of pulse generator (typically 50 $\Omega$ )

**WAVEFORM : PROPAGATION DELAY (f=1MHz; 50% duty cycle)**



## SO-14 MECHANICAL DATA

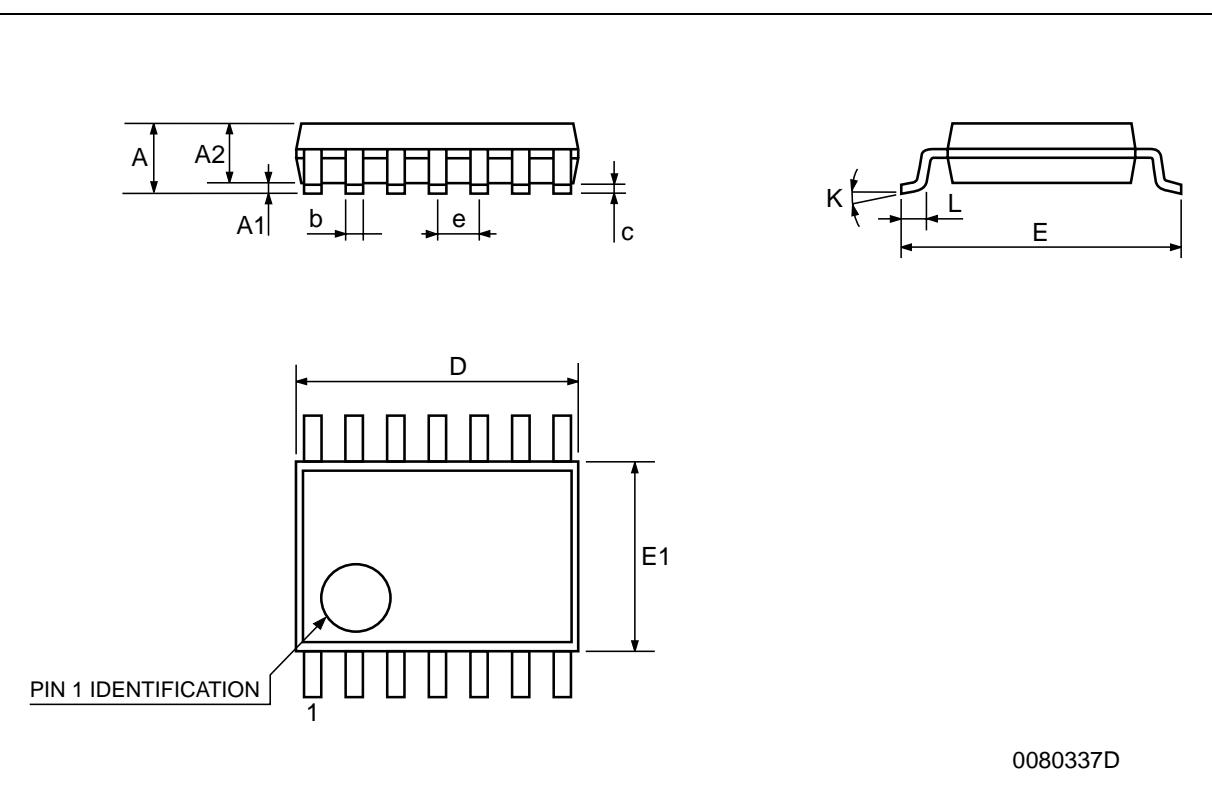
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S	8° (max.)					



PO13G

## TSSOP14 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



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